



HDK8450 Development Kit Quick Start Guide

80-28453-1 Rev. C

Lantronix Document ID: PMD-0134 REV A

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Revision History

Revision	Date	Description
А	September 2021	Initial release.
В	September 2021	Optimize mainboard top/bottom item list sequence.
С	October 2021	Slide 5: updated the figure of main board top.
		Slide 9: updated the figure of Development Kit Accessories.
		Slide 10:updated the figure of Emergency Download.



Contents

Main Board Top

Main Board Bottom

Expansion Card Top

Expansion Card Bottom

Development Kit Accessories

Development Kit Support

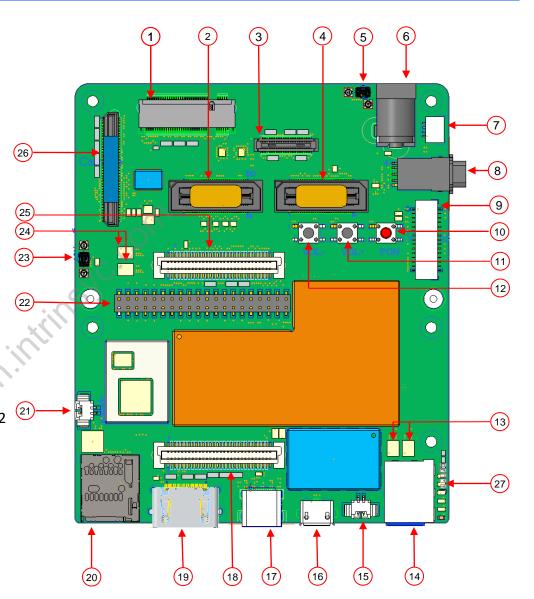
Questions?

Main Board Top

Package Contents

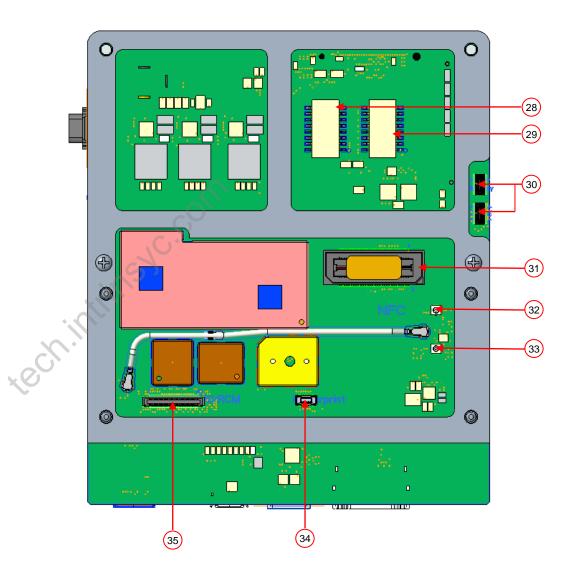
- Main Board with APQ8450 processor
- 12V DC power adaptor
- **USB** cable
- 4. Display Card (optional)
- Camera Card (optional)
- Sensor Card (optional)
- Speaker x 2 (optional)
- Battery (optional)
- M.2 Connector
- Sensor Port2
- Camera Card Connector1
- Sensor Port1
- Beamer2 Connector
- 12V DC Jack
- M.2 USB
- 3.5mm Headset Jack
- Vertigo
- 10. Power Key
- 11. Volume+ key
- 12. Volume- key
- 13. MIC3/4
- 14. SIM CARD
- 15. Receiver Connector
- 16. UART debug Port
- 17. USB Type-C

- 18. High Speed Expansion-1
- 19. HDMI Connector
- 20. SD Socket
- 21. Speaker Connector
- 22. Low Speed Expansion
- 23. Beamer1 Connector
- 24. MIC1/5
- 25. High Speed Expansion-2
- 26. Camera Card Connector2
- 27. User LEDs



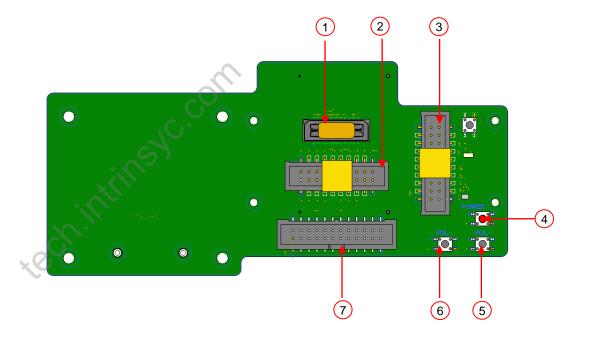
Main Board Bottom

- 28. General Switch(S5702)
- 29. Boot Config Switch(S5701)
- 30. Battery Connector
- 31. NFC Connector
- 32. Wi-Fi CHO Antenna
- 33. Wi-Fi CH1/GNSS Antenna
- 34. Fingerprint Connector
- 35. Debug/RCM Connector



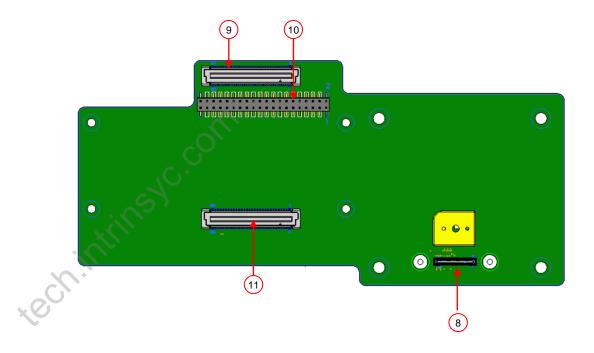
Expansion Card Top

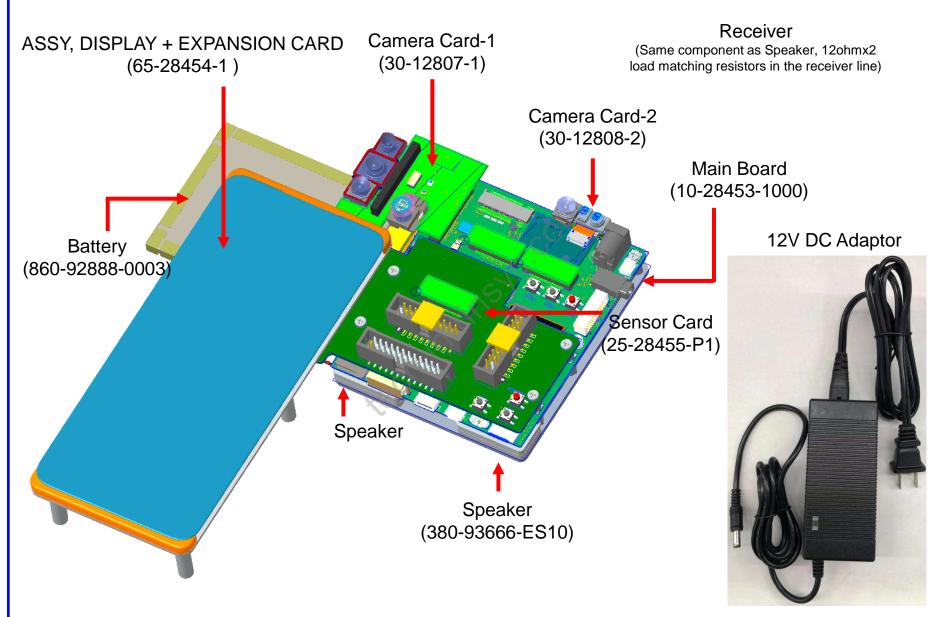
- Sensor Port3
- **Audio Connector**
- JTAG Connector
- Power On
- Volume +
- Volume -
- Sensor Port4 (legacy)



Expansion Card Bottom

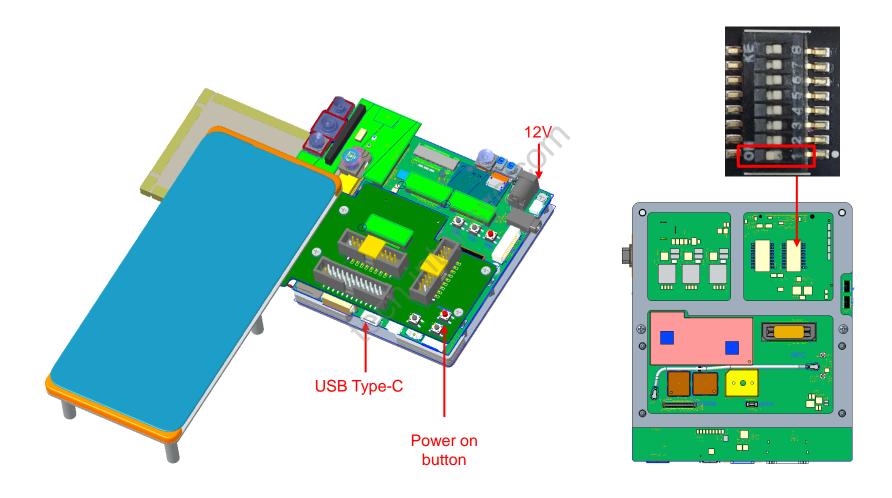
- 8. Display FPC Connector
- 9. High Speed Expansion-2 (DSI1)
- 10. Low Speed Expansion
- 11. High Speed Expansion (DSI0, CSI4/5)





Emergency Download

- 1. Insert the USB Type-C cable.
- 2. Make sure switch1 (Force_usb_boot) is turned ON before power on the device.



Questions?

For additional information or to submit technical questions, go to: https://tech.intrinsyc.com